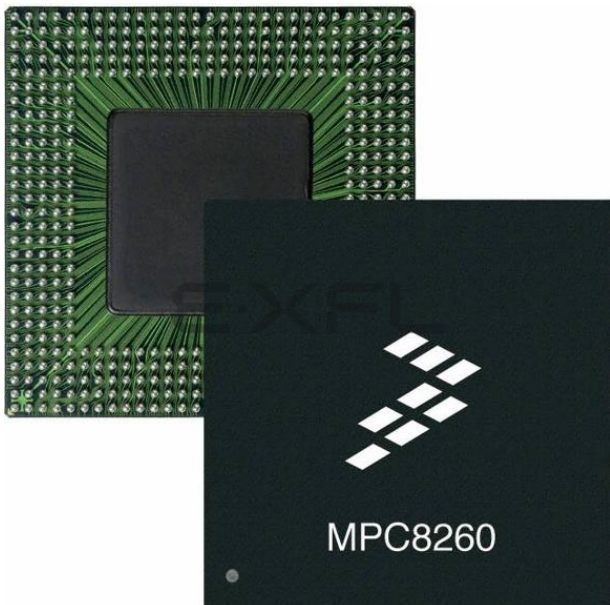




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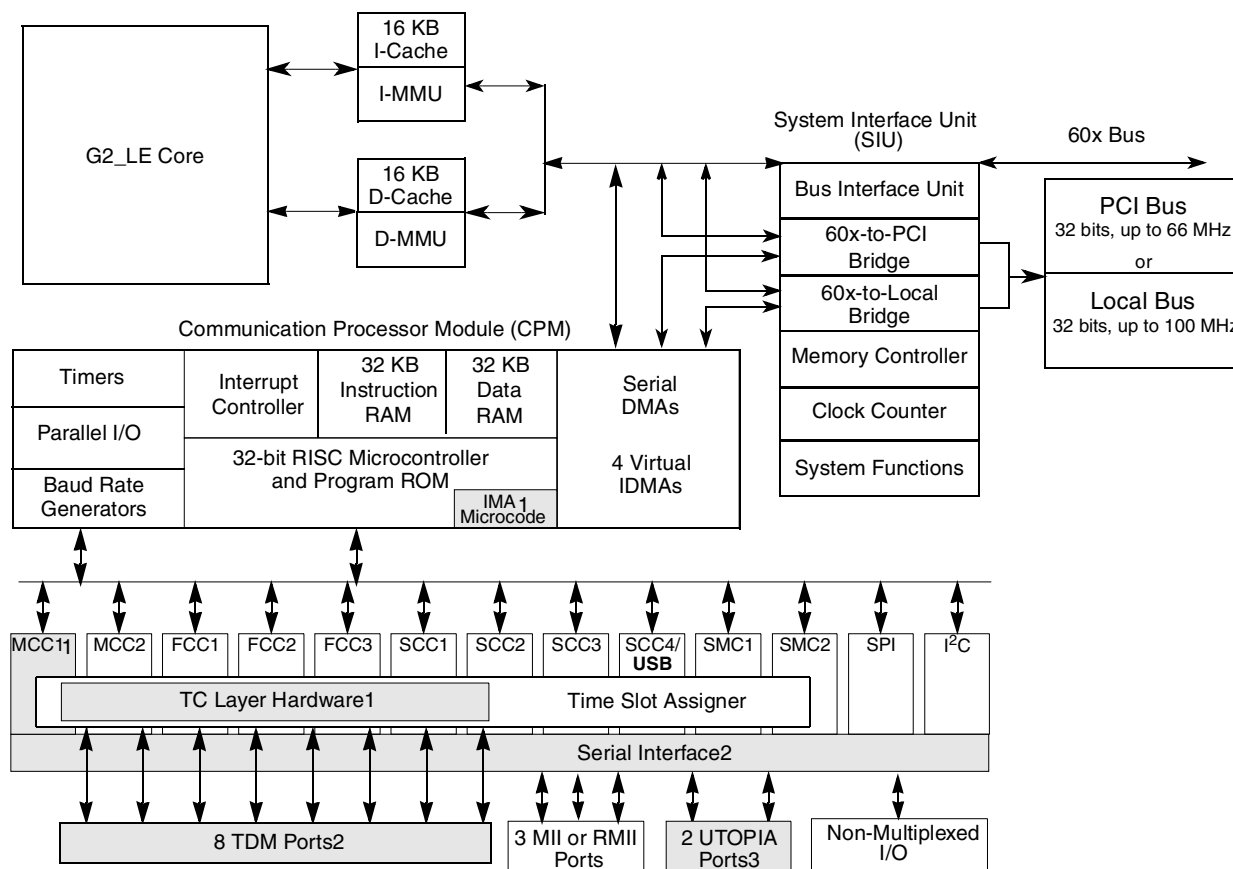
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Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

Product Status	Obsolete
Core Processor	PowerPC G2_LE
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	450MHz
Co-Processors/DSP	Communications; RISC CPM
RAM Controllers	DRAM, SDRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10/100Mbps (3)
SATA	-
USB	USB 2.0 (1)
Voltage - I/O	3.3V
Operating Temperature	-40°C ~ 105°C (TA)
Security Features	-
Package / Case	480-LBGA Exposed Pad
Supplier Device Package	480-TBGA (37.5x37.5)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mpc8270cvvupea

This figure shows the block diagram of the SoC. Shaded portions are SoC-specific; see the notes below the figure.



Notes:

¹ MPC8280 only (**not on MPC8270**, the VR package, nor the ZQ package)

² MPC8280 has 2 serial interface (SI) blocks and 8 TDM ports. MPC8270 and the VR and ZQ packages have only 1 SI block and 4 TDM ports (TDM2[A–D]).

³ MPC8280, MPC8275VR, MPC8275ZQ only (**not on MPC8270**, MPC8270VR, nor MPC8270ZQ)

Figure 1. SoC Block Diagram

1.1 Features

The major features of the SoC are as follows:

- Dual-issue integer (G2_LE) core
 - A core version of the EC603e microprocessor
 - System core microprocessor supporting frequencies of 166–450 MHz
 - Separate 16 KB data and instruction caches:
 - Four-way set associative
 - Physically addressed
 - LRU replacement algorithm
 - Power Architecture®-compliant memory management unit (MMU)

Table 5. DC Electrical Characteristics¹ (continued)

Characteristic	Symbol	Min	Max	Unit
$I_{OL} = 6.0\text{mA}$ $\overline{BR}$ $\overline{BG}$ $\overline{ABB}/\overline{IRQ2}$ $\overline{TS}$ $A[0-31]$ $TT[0-4]$ $\overline{TBST}$ $TSIZE[0-3]$ $\overline{AACK}$ $\overline{ARTRY}$ $\overline{DBG}$ $\overline{DBB}/\overline{IRQ3}$ $D[0-63]$ $DP(0)/\overline{RSRV}/\overline{EXT_BR2}$ $DP(1)/\overline{IRQ1}/\overline{EXT_BG2}$ $DP(2)/\overline{TLBISYNC}/\overline{IRQ2}/\overline{EXT_DBG2}$ $DP(3)/\overline{IRQ3}/\overline{EXT_BR3}/\overline{CKSTP_OUT}$ $DP(4)/\overline{IRQ4}/\overline{EXT_BG3}/\overline{CORE_SREST}$ $DP(5)/\overline{TBEN}/\overline{EXT_DBG3}/\overline{IRQ5}/\overline{CINT}$ $DP(6)/\overline{CSE(0)}/\overline{IRQ6}$ $DP(7)/\overline{CSE(1)}/\overline{IRQ7}$ $\overline{PSDVAL}$ $\overline{TA}$ $\overline{TEA}$ $\overline{GBL}/\overline{IRQ1}$ $\overline{CI}/\overline{BADDR29}/\overline{IRQ2}$ $\overline{WT}/\overline{BADDR30}/\overline{IRQ3}$ $\overline{L2_HIT}/\overline{IRQ4}$ $\overline{CPU_BG}/\overline{BADDR31}/\overline{IRQ5}/\overline{CINT}$ $\overline{CPU_DBG}$ $\overline{CPU_BR}$ $\overline{IRQ0}/\overline{NMI_OUT}$ $\overline{IRQ7}/\overline{PCI_RSTINT_OUT}/\overline{APE}$ $\overline{PORESET}$ $\overline{HRESET}$ $\overline{SRESET}$ $\overline{RSTCONF}$	V_{OL}	—	0.4	V

Table 5. DC Electrical Characteristics¹ (continued)

Characteristic	Symbol	Min	Max	Unit
$I_{OL} = 5.3\text{mA}$ $\overline{CS}[0-9]$ $\overline{CS}(10)/\overline{BCTL1}$ $\overline{CS}(11)/\overline{AP}(0)$ $\overline{BADDR}[27-28]$ $\overline{ALE}$ $\overline{BCTL0}$ $\overline{PWE}[0-7]/\overline{PSDDQM}[0-7]/\overline{PBS}[0-7]$ $\overline{PSDA10}/\overline{PGPL0}$ $\overline{PSDWE}/\overline{PGPL1}$ $\overline{POE}/\overline{PSDRAS}/\overline{PGPL2}$ $\overline{PSDCAS}/\overline{PGPL3}$ $\overline{PGTA}/\overline{PUPMWAIT}/\overline{PGPL4}/\overline{PPBS}$ $\overline{PSDAMUX}/\overline{PGPL5}$ $\overline{LWE}[0-3]/\overline{LSDDQM}[0-3]/\overline{LBS}[0-3]/\overline{PCI_CFG}[0-3]$ $\overline{LSDA10}/\overline{LGPL0}/\overline{PCI_MODCKH0}$ $\overline{LSDWE}/\overline{LGPL1}/\overline{PCI_MODCKH1}$ $\overline{LOE}/\overline{LSDRAS}/\overline{LGPL2}/\overline{PCI_MODCKH2}$ $\overline{LSDCAS}/\overline{LGPL3}/\overline{PCI_MODCKH3}$ $\overline{LGTA}/\overline{LUPMWAIT}/\overline{LGPL4}/\overline{LPBS}$ $\overline{LSDAMUX}/\overline{LGPL5}/\overline{PCI_MODCK}$ $\overline{LWR}$ $\overline{MODCK}[1-3]/\overline{AP}[1-3]/\overline{TC}[0-2]/\overline{BNKSEL}[0-2]$ $I_{OL} = 3.2\text{mA}$ $\overline{L_A14}/\overline{PAR}$ $\overline{L_A15}/\overline{FRAME}/\overline{SMI}$ $\overline{L_A16}/\overline{TRDY}$ $\overline{L_A17}/\overline{IRDY}/\overline{CKSTP_OUT}$ $\overline{L_A18}/\overline{STOP}$ $\overline{L_A19}/\overline{DEVSEL}$ $\overline{L_A20}/\overline{IDSEL}$ $\overline{L_A21}/\overline{PERR}$ $\overline{L_A22}/\overline{SERR}$ $\overline{L_A23}/\overline{REQ0}$ $\overline{L_A24}/\overline{REQ1}/\overline{HSEJSW}$ $\overline{L_A25}/\overline{GNT0}$ $\overline{L_A26}/\overline{GNT1}/\overline{HSLED}$ $\overline{L_A27}/\overline{GNT2}/\overline{HSENUM}$ $\overline{L_A28}/\overline{RST}/\overline{CORE_SRESET}$ $\overline{L_A29}/\overline{INTAL_A30}/\overline{REQ2}$ $\overline{L_A31}$ $\overline{LCL_D}[0-31]/\overline{AD}[0-31]$ $\overline{LCL_DP}[03]/\overline{C}/\overline{BE}[0-3]$ $\overline{PA}[0-31]$ $\overline{PB}[4-31]$ $\overline{PC}[0-31]$ $\overline{PD}[4-31]$ $\overline{TDO}$ $\overline{QREQ}$	V_{OL}	—	0.4	V

¹ The default configuration of the CPM pins ($\overline{PA}[0-31]$, $\overline{PB}[4-31]$, $\overline{PC}[0-31]$, $\overline{PD}[4-31]$) is input. To prevent excessive DC current, either pull unused pins to GND or VDDH or configure them as outputs.

² TCK, TRST and PORESET have min $V_{IH} = 2.5\text{V}$.

³ The leakage current is measured for nominal VDDH, VCCSYN, and VDD.

6 AC Electrical Characteristics

The following sections include illustrations and tables of clock diagrams, signals, and CPM outputs and inputs for 66.67/83.33/100 MHz devices. Note that AC timings are based on a 50-pf load for MAX Delay and 10-pf load for MIN delay. Typical output buffer impedances are shown in this table.

Table 8. Output Buffer Impedances¹

Output Buffers	Typical Impedance (Ω)
60x bus	45 or 27 ²
Local bus	45
Memory controller	45 or 27 ²
Parallel I/O	45
PCI	27

¹ These are typical values at 65° C. Impedance may vary by $\pm 25\%$ with process and temperature.

² On silicon revision 0.0 (mask #: 0K49M), selectable impedance is not available. Impedance is set at 45 Ω .
On all other revisions, impedance value is selected through the SIUMCR[20,21]. See the SoC reference manual.

6.1 CPM AC Characteristics

This table lists CPM output characteristics.

Table 9. AC Characteristics for CPM Outputs¹

Spec Number		Characteristic	Value (ns)					
Max	Min		Maximum Delay			Minimum Delay		
			66 MHz	83 MHz	100 MHz	66 MHz	83 MHz	100 MHz
sp36a	sp37a	FCC outputs—internal clock (NMSI)	6	5.5	5.5	0.5	0.5	0.5
sp36b	sp37b	FCC outputs—external clock (NMSI)	8	8	8	2	2	2
sp38a	sp39a	SCC/SMC/SPI/I2C outputs—internal clock (NMSI)	10	10	10	0	0	0
sp38b	sp39b	SCC/SMC/SPI/I2C outputs—external clock (NMSI)	8	8	8	2	2	2
sp40	sp41	TDM outputs/SI	11	11	11	2.5	2.5	2.5
sp42	sp43	TIMER/IDMA outputs	11	11	11	0.5	0.5	0.5
sp42a	sp43a	PIO outputs	11	11	11	0.5	0.5	0.5

¹ Output specifications are measured from the 50% level of the rising edge of CLKIN to the 50% level of the signal. Timings are measured at the pin.

This table lists CPM input characteristics.

NOTE: Rise/Fall Time on CPM Input Pins

It is recommended that the rise/fall time on CPM input pins should not exceed 5 ns. This should be enforced especially on clock signals. Rise time refers to signal transitions from 10% to 90% of VCC; fall time refers to transitions from 90% to 10% of VCC.

Table 10. AC Characteristics for CPM Inputs¹

Spec Number		Characteristic	Value (ns)					
Setup	Hold		Setup			Hold		
			66 MHz	83 MHz	100 MHz	66 MHz	83 MHz	100 MHz
sp16a	sp17a	FCC inputs—internal clock (NMSI)	6	6	6	0	0	0
sp16b	sp17b	FCC inputs—external clock (NMSI)	2.5	2.5	2.5	2	2	2
sp18a	sp19a	SCC/SMC/SPI/I2C inputs—internal clock (NMSI)	6	6	6	0	0	0
sp18b	sp19b	SCC/SMC/SPI/I2C inputs—external clock (NMSI)	4	4	4	2	2	2
sp20	sp21	TDM inputs/SI	5	5	5	2.5	2.5	2.5
sp22	sp23	PIO/TIMER/IDMA inputs	8	8	8	0.5	0.5	0.5

¹ Input specifications are measured from the 50% level of the signal to the 50% level of the rising edge of CLKIN. Timings are measured at the pin.

NOTE

Although the specifications generally reference the rising edge of the clock, the following AC timing diagrams also apply when the falling edge is the active edge.

This figure shows the FCC internal clock.

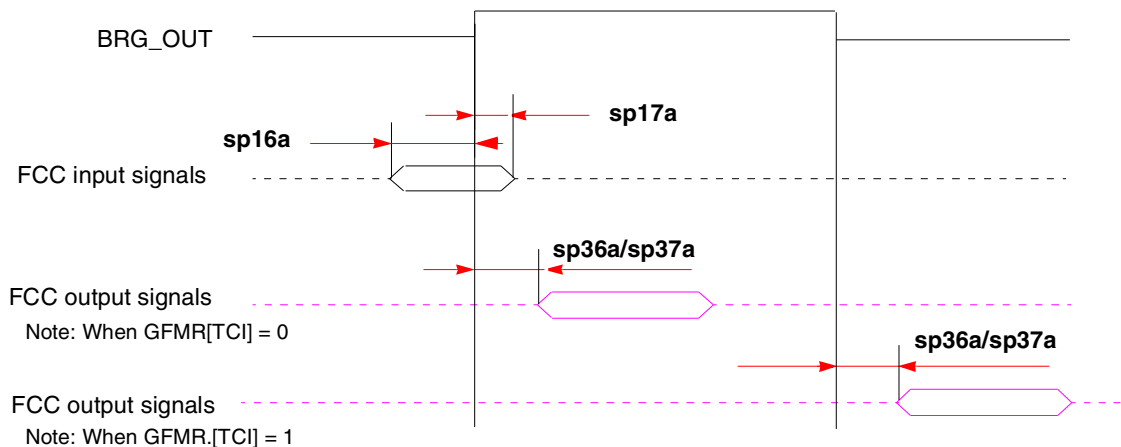


Figure 3. FCC Internal Clock Diagram

NOTE: Conditions

The following conditions must be met in order to operate the MPC8272 family devices with 133 MHz bus: single PowerQUICC II Bus mode must be used (no external master, BCR[EBM] = 0); data bus must be in Pipeline mode (BRx[DR] = 1); internal arbiter and memory controller must be used. For expected load of above 40 pF, it is recommended that data and address buses be configured to low (25 Ω) impedance (SIUMCR[HLBE0] = 1, SIUMCR[HLBE1] = 1).

Table 11. AC Characteristics for SIU Inputs¹

Spec Number		Characteristic	Value (ns)							
Setup	Hold		Setup				Hold			
			66 MHz	83 MHz	100 MHz	133 MHz	66 MHz	83 MHz	100 MHz	133 MHz
sp11	sp10	AACK/TA/TS/DBG/BG/BR/ARTRY/TEA	6	5	3.5	N/A	0.5	0.5	0.5	N/A
sp12	sp10	Data bus in normal mode	5	4	3.5	N/A	0.5	0.5	0.5	N/A
sp13	sp10	Data bus in pipeline mode (without ECC and PARITY)	N/A	4	2.5	1.5	N/A	0.5	0.5	0.5
sp15	sp10	All other pins	5	4	3.5	N/A	0.5	0.5	0.5	N/A

¹ Input specifications are measured from the 50% level of the signal to the 50% level of the rising edge of CLKIN. Timings are measured at the pin.

This table lists SIU output characteristics.

Table 12. AC Characteristics for SIU Outputs¹

Spec Number		Characteristic	Value (ns)							
Max	Min		Maximum Delay				Minimum Delay			
			66 MHz	83 MHz	100 MHz	133 MHz	66 MHz	83 MHz	100 MHz	133 MHz
sp31	sp30	PSDVAL/TEA/TA	7	6	5.5	N/A	1	1	1	N/A
sp32	sp30	ADD/ADD_atr./BADDR/CI/GBL/WT	8	6.5	5.5	4.5 ²	1	1	1	1 ²
sp33	sp30	Data bus ³	6.5	6.5	5.5	4.5	0.8	0.8	0.8	1
sp34	sp30	Memory controller signals/ALE	6	5.5	5.5	4.5	1	1	1	1
sp35	sp30	All other signals	6	5.5	5.5	N/A	1	1	1	N/A

¹ Output specifications are measured from the 50% level of the rising edge of CLKIN to the 50% level of the signal. Timings are measured at the pin.

² Value is for ADD only; other sp32/sp30 signals are not applicable.

³ To achieve 1 ns of hold time at 66.67/83.33/100 MHz, a minimum loading of 20 pF is required.

NOTE

Activating data pipelining (setting BRx[DR] in the memory controller) improves the AC timing.

This table lists SIU input characteristics.

Table 13. AC Characteristics for SIU Inputs¹

Spec Number		Characteristic	Value (ns)					
Setup	Hold		Setup			Hold		
			66 MHz	83 MHz	100 MHz	66 MHz	83 MHz	100 MHz
sp11	sp10	AACK/TA/TS/DBG/BG/BR/ARTRY/TEA	6	5	3.5	0.5	0.5	0.5
sp12	sp10	Data bus in normal mode	5	4	3.5	0.5	0.5	0.5
sp13	sp10	Data bus in ECC and PARITY modes	7	5	3.5	0.5	0.5	0.5
sp13a	sp10	Pipeline mode—Data bus (with or without ECC/PARITY)	5	4	2.5	0.5	0.5	0.5
sp14	sp10	DP pins	7	5	3.5	0.5	0.5	0.5
sp14a	sp10	Pipeline mode—DP pins	—	4	2.5	—	0.5	0.5
sp15	sp10	All other pins	5	4	3.5	0.5	0.5	0.5

¹ Input specifications are measured from the 50% level of the signal to the 50% level of the rising edge of CLKIN. Timings are measured at the pin.

This table lists SIU output characteristics.

Table 14. AC Characteristics for SIU Outputs¹

Spec Number		Characteristic	Value (ns)					
Max	Min		Maximum Delay			Minimum Delay		
			66 MHz	83 MHz	100 MHz	66 MHz	83 MHz	100 MHz
sp31	sp30	PSDVAL/TEA/TA	7	6	5.5	1	1	1
sp32	sp30	ADD/ADD_atr./BADDR/CI/GBL/WT	8	6.5	5.5	1	1	1
sp33a	sp30	Data bus ²	6.5	6.5	5.5	0.7	0.7	0.7
sp33b	sp30	DP	6	5.5	5.5	1	1	1
sp34	sp30	Memory controller signals/ALE	6	5.5	5.5	1	1	1
sp35	sp30	All other signals	6	5.5	5.5	1	1	1
sp35a	sp30	AP	7	7	7	1	1	1

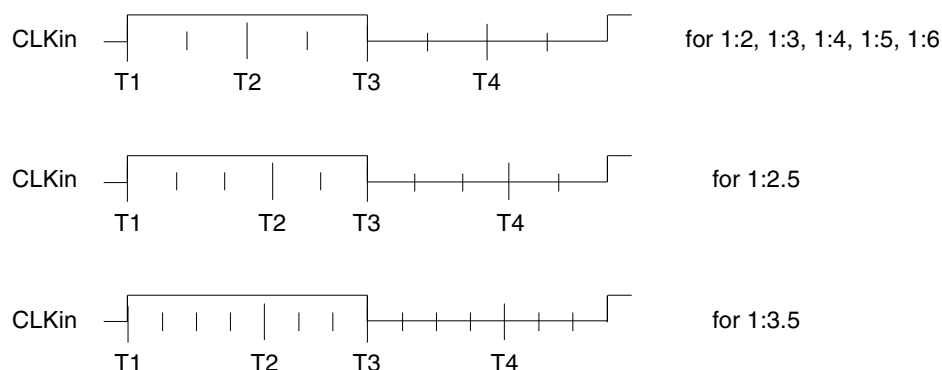
¹ Output specifications are measured from the 50% level of the rising edge of CLKIN to the 50% level of the signal. Timings are measured at the pin.

² To achieve 1 ns of hold time at 66, 83, or 100 MHz, a minimum loading of 20 pF is required.

Table 15. Tick Spacing for Memory Controller Signals

PLL Clock Ratio	Tick Spacing (T1 Occurs at the Rising Edge of CLKIn)		
	T2	T3	T4
1:2, 1:3, 1:4, 1:5, 1:6	1/4 CLKIn	1/2 CLKIn	3/4 CLKIn
1:2.5	3/10 CLKIn	1/2 CLKIn	8/10 CLKIn
1:3.5	4/14 CLKIn	1/2 CLKIn	11/14 CLKIn

This table is a representation of the information in [Table 15](#).


Figure 12. Internal Tick Spacing for Memory Controller Signals

NOTE

The UPM machine outputs change on the internal tick determined by the memory controller programming; the AC specifications are relative to the internal tick. Note that SDRAM and GPCM machine outputs change on CLKIn's rising edge.

6.3 JTAG Timings

This table lists the JTAG timings.

Table 16. JTAG Timings¹

Parameter	Symbol ²	Min	Max	Unit	Notes
JTAG external clock frequency of operation	f_{JTG}	0	33.3	MHz	—
JTAG external clock cycle time	t_{JTG}	30	—	ns	—
JTAG external clock pulse width measured at 1.4V	t_{JTKHKL}	15	—	ns	—
JTAG external clock rise and fall times	t_{JTGR} and t_{JTGF}	0	5	ns	⁶
TRST assert time	t_{TRST}	25	—	ns	^{3, 6}
Input setup times Boundary-scan data TMS, TDI	t_{JTDVKH}	4	—	ns	^{4, 7}
	t_{JTIVKH}	4	—	ns	^{4, 7}

Table 17. SoC Clocking Modes

Pins			Clocking Mode	PCI Clock Frequency Range (MHZ)	Reference
PCI_MODE	PCI_CFG[0]	PCI_MODCK ¹			
1	—	—	Local bus	—	Table 18
0	0	0	PCI host	50–66	Table 19
0	0	1		25–50	Table 20
0	1	0	PCI agent	50–66	Table 21
0	1	1		25–50	Table 22

¹ Determines PCI clock frequency range. See [Section 7.2, “PCI Host Mode,”](#) and [Section 7.3, “PCI Agent Mode.”](#)

Within each mode, the configuration of bus, core, PCI, and CPM frequencies is determined by seven bits during the power-on reset—three hardware configuration pins (MODCK[1–3]) and four bits from hardware configuration word[28–31] (MODCK_H). Both the PLLs and the dividers are set according to the selected clock operation mode as described in the following sections.

7.1 Local Bus Mode

This table lists clock configurations for the SoC in local bus mode. The frequencies listed are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device.

NOTE

Clock configurations change only after $\overline{\text{PORESET}}$ is asserted.

Table 18. Clock Configurations for Local Bus Mode¹

Mode ²	Bus Clock ³ (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)	
MODCK_H-MODCK[1:3]	Low	High		Low	High		Low	High
Default Modes (MODCK_H= 0000)								
0000_000	37.5	133.3	3	112.5	400.0	4	150.0	533.3
0000_001	33.3	133.3	3	100.0	400.0	5	166.7	666.7
0000_010	37.5	100.0	4	150.0	400.0	4	150.0	400.0
0000_011	30.0	100.0	4	120.0	400.0	5	150.0	500.0
0000_100	60.0	167.0	2	120.0	334.0	2.5	150.0	417.5
0000_101	50.0	167.0	2	100.0	334.0	3	150.0	501.0
0000_110	60.0	160.0	2.5	150.0	400.0	2.5	150.0	400.0
0000_111	50.0	160.0	2.5	125.0	400.0	3	150.0	480.0
Full Configuration Modes								
0001_000	50.0	167.0	2	100.0	334.0	4	200.0	668.0

Table 18. Clock Configurations for Local Bus Mode¹ (continued)

Mode ²	Bus Clock ³ (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)	
	Low	High		Low	High		Low	High
0110_000	50.0	167.0	2	100.0	334.0	3.5	250.0	584.5
0110_001	50.0	167.0	2	100.0	334.0	4	250.0	668.0
0110_010	50.0	167.0	2	100.0	334.0	4.5	250.0	751.5
0110_011	Reserved							
0110_100	60.0	160.0	2.5	150.0	400.0	2.5	150.0	400.0
0110_101	50.0	160.0	2.5	125.0	400.0	3	150.0	480.0
0110_110	42.9	160.0	2.5	107.1	400.0	3.5	150.0	560.0
0110_111	40.0	160.0	2.5	100.0	400.0	4	160.0	640.0
0111_000	40.0	160.0	2.5	100.0	400.0	4.5	180.0	720.0
0111_001	Reserved							
0111_010	Reserved							
0111_011	50.0	133.3	3	150.0	400.0	3	150.0	400.0
0111_100	42.9	133.3	3	128.6	400.0	3.5	150.0	466.7
0111_101	37.5	133.3	3	112.5	400.0	4	150.0	533.3
0111_110	33.3	133.3	3	100.0	400.0	4.5	150.0	600.0
0111_111	Reserved							
1000_000	Reserved							
1000_001	Reserved							
1000_010	42.9	114.3	3.5	150.0	400.0	3.5	150.0	400.0
1000_011	37.5	114.3	3.5	131.3	400.0	4	150.0	457.1
1000_100	33.3	114.3	3.5	116.7	400.0	4.5	150.0	514.3
1000_101	30.0	114.3	3.5	105.0	400.0	5	150.0	571.4
1000_110	28.6	114.3	3.5	100.0	400.0	5.5	150.0	628.6
1100_000	Reserved							
1100_001	Reserved							
1100_010	Reserved							
1101_000	Reserved							

Table 20. Clock Configurations for PCI Host Mode (PCI_MODCK=1)^{1,2} (continued)

Mode ³	Bus Clock ⁴ (MHz)		CPM Multiplication Factor ⁵	CPM Clock (MHz)		CPU Multiplication Factor ⁶	CPU Clock (MHz)		PCI Division Factor	PCI Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
0010_110	37.5	75.0	4	150.0	300.0	6	225.0	450.0	6	25.0	50.0
0011_000	30.0	50.0	5	150.0	250.0	5	150.0	250.0	5	30.0	50.0
0011_001	25.0	50.0	5	125.0	250.0	6	150.0	300.0	5	25.0	50.0
0011_010	25.0	50.0	5	125.0	250.0	7	175.0	350.0	5	25.0	50.0
0011_011	25.0	50.0	5	125.0	250.0	8	200.0	400.0	5	25.0	50.0
0100_000	Reserved										
0100_001	25.0	50.0	6	150.0	300.0	6	150.0	300.0	6	25.0	50.0
0100_010	25.0	50.0	6	150.0	300.0	7	175.0	350.0	6	25.0	50.0
0100_011	25.0	50.0	6	150.0	300.0	8	200.0	400.0	6	25.0	50.0
0101_000	60.0	100.0	2	120.0	200.0	2.5	150.0	250.0	4	30.0	50.0
0101_001	50.0	100.0	2	100.0	200.0	3	150.0	300.0	4	25.0	50.0
0101_010	50.0	100.0	2	100.0	200.0	3.5	175.0	350.0	4	25.0	50.0
0101_011	50.0	100.0	2	100.0	200.0	4	200.0	400.0	4	25.0	50.0
0101_100	50.0	100.0	2	100.0	200.0	4.5	225.0	450.0	4	25.0	50.0
0110_000	60.0	120.0	2.5	150.0	300.0	2.5	150.0	300.0	6	25.0	50.0
0110_001	60.0	120.0	2.5	150.0	300.0	3	180.0	360.0	6	25.0	50.0
0110_010	60.0	120.0	2.5	150.0	300.0	3.5	210.0	420.0	6	25.0	50.0
0110_011	60.0	120.0	2.5	150.0	300.0	4	240.0	480.0	6	25.0	50.0
0110_100	60.0	120.0	2.5	150.0	300.0	4.5	270.0	540.0	6	25.0	50.0
0110_101	60.0	120.0	2.5	150.0	300.0	5	300.0	600.0	6	25.0	50.0
0110_110	60.0	120.0	2.5	150.0	300.0	6	360.0	720.0	6	25.0	50.0
0111_000	Reserved										
0111_001	50.0	100.0	3	150.0	300.0	3	150.0	300.0	6	25.0	50.0
0111_010	50.0	100.0	3	150.0	300.0	3.5	175.0	350.0	6	25.0	50.0
0111_011	50.0	100.0	3	150.0	300.0	4	200.0	400.0	6	25.0	50.0
0111_100	50.0	100.0	3	150.0	300.0	4.5	225.0	450.0	6	25.0	50.0

Table 20. Clock Configurations for PCI Host Mode (PCI_MODCK=1)^{1,2} (continued)

Mode ³	Bus Clock ⁴ (MHz)		CPM Multiplication Factor ⁵	CPM Clock (MHz)		CPU Multiplication Factor ⁶	CPU Clock (MHz)		PCI Division Factor	PCI Clock (MHz)	
MODCK_H- MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
1000_000	Reserved										
1000_001	66.7	133.3	3	200.0	400.0	3	200.0	400.0	8	25.0	50.0
1000_010	66.7	133.3	3	200.0	400.0	3.5	233.3	466.7	8	25.0	50.0
1000_011	66.7	133.3	3	200.0	400.0	4	266.7	533.3	8	25.0	50.0
1000_100	66.7	133.3	3	200.0	400.0	4.5	300.0	600.0	8	25.0	50.0
1000_101	66.7	133.3	3	200.0	400.0	6	400.0	800.0	8	25.0	50.0
1000_110	66.7	133.3	3	200.0	400.0	6.5	433.3	866.7	8	25.0	50.0
1001_000	Reserved										
1001_001	Reserved										
1001_010	57.1	114.3	3.5	200.0	400.0	3.5	200.0	400.0	8	25.0	50.0
1001_011	57.1	114.3	3.5	200.0	400.0	4	228.6	457.1	8	25.0	50.0
1001_100	57.1	114.3	3.5	200.0	400.0	4.5	257.1	514.3	8	25.0	50.0
1001_101	42.9	85.7	3.5	150.0	300.0	5	214.3	428.6	6	25.0	50.0
1001_110	42.9	85.7	3.5	150.0	300.0	5.5	235.7	471.4	6	25.0	50.0
1001_111	42.9	85.7	3.5	150.0	300.0	6	257.1	514.3	6	25.0	50.0
1010_000	75.0	150.0	2	150.0	300.0	2	150.0	300.0	6	25.0	50.0
1010_001	75.0	150.0	2	150.0	300.0	2.5	187.5	375.0	6	25.0	50.0
1010_010	75.0	150.0	2	150.0	300.0	3	225.0	450.0	6	25.0	50.0
1010_011	75.0	150.0	2	150.0	300.0	3.5	262.5	525.0	6	25.0	50.0
1010_100	75.0	150.0	2	150.0	300.0	4	300.0	600.0	6	25.0	50.0
1011_000	Reserved										
1011_001	80.0	160.0	2.5	200.0	400.0	2.5	200.0	400.0	8	25.0	50.0
1011_010	80.0	160.0	2.5	200.0	400.0	3	240.0	480.0	8	25.0	50.0
1011_011	80.0	160.0	2.5	200.0	400.0	3.5	280.0	560.0	8	25.0	50.0
1011_100	80.0	160.0	2.5	200.0	400.0	4	320.0	640.0	8	25.0	50.0
1011_101	80.0	160.0	2.5	200.0	400.0	4.5	360.0	720.0	8	25.0	50.0
1101_000	50.0	100.0	2.5	125.0	250.0	3	150.0	300.0	5	25.0	50.0

Table 20. Clock Configurations for PCI Host Mode (PCI_MODCK=1)^{1,2} (continued)

Mode ³	Bus Clock ⁴ (MHz)		CPM Multiplication Factor ⁵	CPM Clock (MHz)		CPU Multiplication Factor ⁶	CPU Clock (MHz)		PCI Division Factor	PCI Clock (MHz)	
	Low	High		Low	High		Low	High		Low	High
1101_001	50.0	100.0	2.5	125.0	250.0	3.5	175.0	350.0	5	25.0	50.0
1101_010	50.0	100.0	2.5	125.0	250.0	4	200.0	400.0	5	25.0	50.0
1101_011	50.0	100.0	2.5	125.0	250.0	4.5	225.0	450.0	5	25.0	50.0
1101_100	50.0	100.0	2.5	125.0	250.0	5	250.0	500.0	5	25.0	50.0
1101_101	62.5	125.0	2	125.0	250.0	3	187.5	375.0	5	25.0	50.0
1101_110	62.5	125.0	2	125.0	250.0	4	250.0	500.0	5	25.0	50.0
1110_000	50.0	100.0	3	150.0	300.0	3.5	175.0	350.0	6	25.0	50.0
1110_001	50.0	100.0	3	150.0	300.0	4	200.0	400.0	6	25.0	50.0
1110_010	50.0	100.0	3	150.0	300.0	4.5	225.0	450.0	6	25.0	50.0
1110_011	50.0	100.0	3	150.0	300.0	5	250.0	500.0	6	25.0	50.0
1110_100	50.0	100.0	3	150.0	300.0	5.5	275.0	550.0	6	25.0	50.0
1100_000	Reserved										
1100_001	Reserved										
1100_010	Reserved										

¹ The “low” values are the minimum allowable frequencies for a given clock mode. The minimum bus frequency in a table entry guarantees only the required minimum CPU operating frequency. The “high” values are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not violate the frequency rating of the user’s device. The minimum CPM frequency is 120 MHz. Minimum CPU frequency is determined by the clock mode. For modes with a CPU multiplication factor ≤ 3 , the minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices. For modes with a CPU multiplication factor ≥ 3.5 : for Rev0.1 the minimum CPU frequency is 250 MHz; for Rev A or later the minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices.

² As Table 17 shows, PCI_MODCK determines the PCI clock frequency range. See Table 20 for higher configurations.

³ MODCK_H = hard reset configuration word [28–31]. MODCK[1-3] = three hardware configuration pins.

⁴ 60x and local bus frequency. Identical to CLKIN.

⁵ CPM multiplication factor = CPM clock/bus clock

⁶ CPU multiplication factor = Core PLL multiplication factor

7.3 PCI Agent Mode

These tables show configurations for PCI agent mode. The frequency values listed are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device. Note that in PCI agent mode the following:

Table 21. Clock Configurations for PCI Agent Mode (PCI_MODCK=0)^{1,2} (continued)

Mode ³	PCI Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
0100_000	Reserved										
0100_001	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0100_010	50.0	66.7	3	150.0	200.0	3.5	175.0	200.0	3	50.0	66.7
0100_011	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
0100_100	50.0	66.7	3	150.0	200.0	4.5	225.0	300.0	3	50.0	66.7
0101_000	50.0	66.7	5	250.0	333.3	2.5	250.0	333.3	2.5	100.0	133.3
0101_001	50.0	66.7	5	250.0	333.3	3	300.0	400.0	2.5	100.0	133.3
0101_010	50.0	66.7	5	250.0	333.3	3.5	350.0	466.6	2.5	100.0	133.3
0101_011	50.0	66.7	5	250.0	333.3	4	400.0	533.3	2.5	100.0	133.3
0101_100	50.0	66.7	5	250.0	333.3	4.5	450.0	599.9	2.5	100.0	133.3
0101_101	50.0	66.7	5	250.0	333.3	5	500.0	666.6	2.5	100.0	133.3
0101_110	50.0	66.7	5	250.0	333.3	5.5	550.0	733.3	2.5	100.0	133.3
0110_000	Reserved										
0110_001	50.0	66.7	4	200.0	266.6	3	200.0	266.6	3	66.7	88.9
0110_010	50.0	66.7	4	200.0	266.6	3.5	233.3	311.1	3	66.7	88.9
0110_011	50.0	66.7	4	200.0	266.6	4	266.7	355.5	3	66.7	88.9
0110_100	50.0	66.7	4	200.0	266.6	4.5	300.0	400.0	3	66.7	88.9
0111_000	50.0	66.7	3	150.0	200.0	2	150.0	200.0	2	75.0	100.0
0111_001	50.0	66.7	3	150.0	200.0	2.5	187.5	250.0	2	75.0	100.0
0111_010	50.0	66.7	3	150.0	200.0	3	225.0	300.0	2	75.0	100.0
0111_011	50.0	66.7	3	150.0	200.0	3.5	262.5	350.0	2	75.0	100.0
1000_000	Reserved										
1000_001	50.0	66.7	3	150.0	200.0	2.5	150.0	166.7	2.5	60.0	80.0
1000_010	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0
1000_011	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0
1000_100	50.0	66.7	3	150.0	200.0	4	240.0	320.0	2.5	60.0	80.0
1000_101	50.0	66.7	3	150.0	200.0	4.5	270.0	360.0	2.5	60.0	80.0

Table 22. Clock Configurations for PCI Agent Mode (PCI_MODCK=1)^{1,2} (continued)

Mode ³	PCI Clock (MHz)		CPM Multiplication Factor ⁴	CPM Clock (MHz)		CPU Multiplication Factor ⁵	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
1011_010	25.0	50.0	8	200.0	400.0	3	240.0	480.0	2.5	80.0	160.0
1011_011	25.0	50.0	8	200.0	400.0	3.5	280.0	560.0	2.5	80.0	160.0
1011_100	25.0	50.0	8	200.0	400.0	4	320.0	640.0	2.5	80.0	160.0
1100_101	25.0	50.0	6	150.0	300.0	4	200.0	400.0	3	50.0	100.0
1100_110	25.0	50.0	6	150.0	300.0	4.5	225.0	450.0	3	50.0	100.0
1100_111	25.0	50.0	6	150.0	300.0	5	250.0	500.0	3	50.0	100.0
1101_000	25.0	50.0	6	150.0	300.0	5.5	275.0	550.0	3	50.0	100.0
1101_001	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
1101_010	25.0	50.0	6	150.0	300.0	4	240.0	480.0	2.5	60.0	120.0
1101_011	25.0	50.0	6	150.0	300.0	4.5	270.0	540.0	2.5	60.0	120.0
1101_100	25.0	50.0	6	150.0	300.0	5	300.0	600.0	2.5	60.0	120.0
1110_000	25.0	50.0	5	125.0	250.0	2.5	156.3	312.5	2	62.5	125.0
1110_001	25.0	50.0	5	125.0	250.0	3	187.5	375.0	2	62.5	125.0
1110_010	25.0	50.0	5	125.0	250.0	3.5	218.8	437.5	2	62.5	125.0
1110_011	25.0	50.0	5	125.0	250.0	4	250.0	500.0	2	62.5	125.0
1110_100	25.0	50.0	5	125.0	250.0	4	166.7	333.3	3	41.7	83.3
1110_101	25.0	50.0	5	125.0	250.0	4.5	187.5	375.0	3	41.7	83.3
1110_110	25.0	50.0	5	125.0	250.0	5	208.3	416.7	3	41.7	83.3
1110_111	25.0	50.0	5	125.0	250.0	5.5	229.2	458.3	3	41.7	83.3
1100_000	Reserved										
1100_001	Reserved										
1100_010	Reserved										

¹ The “low” values are the minimum allowable frequencies for a given clock mode. The minimum bus frequency in a table entry guarantees only the required minimum CPU operating frequency. The “high” values are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not violate the frequency rating of the user’s device. The minimum CPM frequency is 120 MHz. Minimum CPU frequency is determined by the clock mode. For modes with a CPU multiplication factor ≤ 3, the minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices. For modes with a CPU multiplication factor ≥ 3.5: for Rev 0.1 the minimum CPU frequency is 250 MHz; for Rev A or later the minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices.

Table 23. MPC8280 and MPC8270 (ZU and VV Packages) Pinout List (continued)

Pin Name		Ball
MPC8280/MPC8270	MPC8280 only	
LCL_D9/AD9		L26
LCL_D10/AD10		L25
LCL_D11/AD11		M29
LCL_D12/AD12		M28
LCL_D13/AD13		M27
LCL_D14/AD14		M26
LCL_D15/AD15		N29
LCL_D16/AD16		T25
LCL_D17/AD17		U27
LCL_D18/AD18		U26
LCL_D19/AD19		U25
LCL_D20/AD20		V29
LCL_D21/AD21		V28
LCL_D22/AD22		V27
LCL_D23/AD23		V26
LCL_D24/AD24		W27
LCL_D25/AD25		W26
LCL_D26/AD26		W25
LCL_D27/AD27		Y29
LCL_D28/AD28		Y28
LCL_D29/AD29		Y25
LCL_D30/AD30		AA29
LCL_D31/AD31		AA28
LCL_DP0/C0/ $\overline{\text{BE}}0$		L28
LCL_DP1/C1/ $\overline{\text{BE}}1$		N28
LCL_DP2/C2/ $\overline{\text{BE}}2$		T28
LCL_DP3/C3/ $\overline{\text{BE}}3$		W28
$\overline{\text{IRQ}}0/\text{NMI_OUT}$		T1
$\overline{\text{IRQ}}7/\text{INT_OUT}/\text{APE}$		D1
$\overline{\text{TRST}}^1$		AH3
TCK		AG5
TMS		AJ3
TDI		AE6

Table 23. MPC8280 and MPC8270 (ZU and VV Packages) Pinout List (continued)

Pin Name		Ball
MPC8280/MPC8270	MPC8280 only	
PD20/ $\overline{\text{RTS4}}$ /TENA4/L1RSYNCA2/ USB_TP	FCC1_UT16_RXD2	AJ14 ²
PD21/TXD4/L1RXD0A2/L1RXDA2/ USB_TN	FCC1_UT16_RXD3	AH13 ²
PD22/RXD4/L1TXD0A2/L1TXDA2/ USB_RXD	FCC1_UT16_TXD5	AJ12 ²
PD23/ $\overline{\text{RTS3}}$ /TENA3	FCC1_UT16_RXD4/L1RSYNCD1	AE12 ²
PD24/TXD3	FCC1_UT16_RXD5/L1RXDD1	AF10 ²
PD25/RXD3	FCC1_UT16_TXD6/L1TXDD1	AG9 ²
PD26/ $\overline{\text{RTS2}}$ /TENA2	FCC1_UT16_RXD6/L1RSYNCC1	AH8 ²
PD27/TXD2	FCC1_UT16_RXD7/L1RXDC1	AG7 ²
PD28/RXD2	FCC1_UT16_TXD7/L1TXDC1	AE4 ²
PD29/ $\overline{\text{RTS1}}$ /TENA1	FCC1_UTM_RXADDR3/ FCC1_UTS_RXADDR3/ FCC1_UTM_RXCLAV2/ FCC2_UTM_RXADDR4/ FCC2_UTS_RXADDR1	AG1 ²
PD30/TXD1	FCC2_UTM_TXENB/ FCC2_UTS_TXENB	AD4 ²
PD31/RXD1		AD2 ²
VCCSYN		AB3
VCCSYN1		B9
CLKIN2		AE11
SPARE4 ³		U5
PCI_MODE ⁴		AF25
SPARE6 ³		V4
No connect ⁵		AA1, AG4
I/O power		AG21, AG14, AG8, AJ1, AJ2, AH1, AH2, AG3, AF4, AE5, AC27, Y27, T27, P27, K26, G27, AE25, AF26, AG27, AH28, AH29, AJ28, AJ29, C7, C14, C16, C20, C23, E10, A28, A29, B28, B29, C27, D26, E25, H3, M4, T3, AA4, A1, A2, B1, B2, C3, D4, E5

Table 25. MPC8275 and MPC8270 (VR and ZQ Packages) Pinout List (continued)

Pin Name		Ball
MPC8275/MPC8270	MPC8275 only	
A0		D5
A1		E8
A2		C4
A3		B4
A4		A4
A5		D7
A6		D8
A7		C6
A8		B5
A9		B6
A10		C7
A11		C8
A12		A6
A13		D9
A14		F11
A15		B7
A16		B8
A17		C9
A18		A7
A19		B9
A20		E11
A21		A8
A22		D11
A23		B10
A24		C11
A25		A9
A26		B11
A27		C12
A28		D12
A29		A10
A30		B12
A31		B13
TT0		E7

Table 25. MPC8275 and MPC8270 (VR and ZQ Packages) Pinout List (continued)

Pin Name		Ball
MPC8275/MPC8270	MPC8275 only	
D20		M2
D21		K2
D22		J1
D23		G4
D24		U5
D25		T5
D26		P5
D27		P3
D28		M3
D29		K3
D30		H2
D31		G5
D32		AA1
D33		V2
D34		U1
D35		P2
D36		M4
D37		K4
D38		H3
D39		F2
D40		Y2
D41		U3
D42		T2
D43		N2
D44		M5
D45		K1
D46		H4
D47		F1
D48		W2
D49		T4
D50		R3
D51		N4
D52		M1

Table 27. Document Revision History (continued)

Revision	Date	Substantive Changes
1.0	2/2004	- Removal of "Advance Information" and "Preliminary." The MPC8280 is fully qualified. - Table 2: New - Figure 1: Modification to note 2 - Section 1.1: Core frequency range is 166–450 MHz - Addition of ZQ (516 PBGA with Lead spheres) package references - Table 4: VDD and VCCSYN modified to 1.45–1.60 V - Note following Table 4: Modified - Table 5: Addition of note 2 regarding $\overline{\text{TRST}}$ and $\overline{\text{PORESET}}$ (see VIH row of Table 5) - Table 5: Changed I_{OL} for 60x signals to 6.0 mA - Table 5: Moved QREQ to V_{OL}: $I_{OL} = 3.2$ mA - Table 5: Addition of critical interrupt ($\overline{\text{CINT}}$) to $\overline{\text{IRQ5}}$ for V_{OL} ($I_{OL} = 6.0$ mA) - Table 10: Addition of Ψ_{JT} and note 4 - Sections 4.1–4.5: New - Table 12: Modified power values (+ 150mW to each) - Table 14: Addition of note 2. Changed PCI impedance to 27 Ω. - Table 9: Changes to sp36b, SP38a, sp38b, sp37a, sp39a, sp40 and sp41 - Table 20: Changes to sp16a, sp18a, sp20 and sp21 - Section 6.2: Addition of Note: CLKIN Jitter and Duty Cycle - Table 11: Changes to sp13 @ 66 and 83 MHz, sp14 @ 83 MHz - Table 12: Change to sp30 (data bus signals). Changes to sp33b. Removal of note 2. - Table 18 through Table 37: Modification of note 1 regarding CPU and CPM Fmin. Modification to corresponding values in tables. - Table 23: Addition of note 1 to $\overline{\text{TRST}}$ (AH3) and $\overline{\text{PORESET}}$ (AG6) - Table 23: Addition of RXD3 to CPM port pin PB14. Previously omitted. - Table 23: Addition of critical interrupt ($\overline{\text{CINT}}$) to B21 and U4. Previously omitted. - Table 23: Addition of note 5 to 'No connect' (AA1, AG4) - Addition of "Note: Temperature Reflow for the VR Package" on page 76 - Table 25: Addition of note 1 to $\overline{\text{TRST}}$ (F22) and $\overline{\text{PORESET}}$ (B25) - Table 25: Addition of previously omitted signals that are multiplexed with CPM port pins: PA6—FCC2_UT_RXADDR3 PA7—FCC2_UT_TXADDR3 PA8—FCC2_UT_TXADDR4 PB14—RXD3 PC19—SPICLK PC22—FCC1_UT_TXPRTY PC28—FCC2_UT_RXADDR4 - Table 25: Removal of serial interface 1 (SI1) signals from port pins (see note 2 in Figure 1): PA[6–9], PB[8–17, 20–25], PC[6–7, 10–13], PD[4, 10–13, 16, 23–28] - Table 25: Addition of critical interrupt ($\overline{\text{CINT}}$) to AC1 and B14. Previously omitted. - Table 25: Addition of note 5 to 'No connect' (E17, C23)